PCN Number:				Augu	August 23, 2018		
Title: Datasheet fo	r TCA4311A						
Customer Contact:	PCN Manager			De	pt:	Quality Services	
Change Type:							
		sign	ign		Wafer	[.] Bump Site	
Assembly Process		🔀 Data Sheet				Bump Material	
Assembly Material		Part number change				Bump Process	
Mechanical Specification		Test Site				Fab Site	
Packing/Shipping/Labeling		Test Process				Fab Materials	
Notification Details							
Description of Change:							
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details. Reissue Original PCN; possible system error							
INSTRUMENTS	Ostahan 2014) ta Daviai			SCPS226	C – JANUAF	TCA4311A RY 2011-REVISED AUGUST 2018	
Changes from Revision B (October 2014) to Revision C Page							
Moved T _{stg} to the Absolute Maximum Rating table							
The datasheet number	will be changing.				-		
Device Family		Cha	nge From:		Change	e To:	
TCA4311A		SCF	S226B		SCPS2	26C	
These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/TCA4311A							
Reason for Change:							
To accurately reflect de	evice characteristics						
Anticipated impact o			uality or Reli	ability	/ (posi	tive / negative):	
No anticipated impact. the actual device.		-		-			
Changes to product identification resulting from this PCN:							
None.							
Product Affected:							
TCA4311ADGKR	TCA4311ADR						
For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.							

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com